MMIC Power Splitter/Combiner Die



2 Way-0° 50 Ω DC to 8 GHz

The Big Deal

- Ultra-Wide Bandwidth, DC to 8 GHz
- High Isolation, 21 dB typ. at 4 GHz
- High Power Handling, 0.6W as a splitter/combiner



Product Overview

Mini-Circuits' EP2RCW-D+ is a MMIC 2-way 0° splitter/combiner Die designed for wideband operation from DC to 8 GHz supporting many applications requiring high performance across a wide frequency range including all the LTE bands through WiMax an WiFi, as well as instrumentation and more. This model provides excellent power handling up to 0.6W (as a splitter/combiner) with low insertion loss, good isolation, and low phase and amplitude unbalance. Manufactured using GaAs IPD technology, the EP2RCW-D+ provides a high level of ESD protection and excellent repeatability.

Key Features

| Feature | Advantages | | | |
|-----------------------------------------------------------------------------------------------|------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|--|--|--|
| Wideband, DC to 8 GHz | One power splitter can be used in all the LTE bands through WiMAX and WiFi, saving compo- nent count. Also ideal for wideband applications such as military and instrumentation. | | | |
| Excellent power handling • 0.6W as a splitter • 0.6W internal dissipation as a combiner | In power combiner applications, half the power is dissipated internally. EP2RCW-D+ is designed to handle 0.6W internal dissipation as a combiner allowing reliable operation without excessive temperature rise. | | | |
| Unpackaged Die | Enables user to integrate it directly into hybrids. | | | |

MMIC Power Splitter/Combiner Die

2 Way-0° 50 Ω DC to 8 GHz

Product Features

- Wide bandwidth, DC to 8 GHz
- Excellent isolation, 21 dB typ. up to 4 GHz
- Excellent amplitude unbalance, 0.1 dB typ. up to 8 GHz
- Good phase unbalance, 0.1 deg. typ. at 4 GHz
- High ESD level
- Patent pending

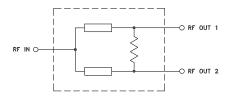
Typical Applications

- WIMAX
- ISM
- Instrumentation
- Radar
- WLAN
- Satellite communications
- LTE

General Description

Mini-Circuits' EP2RCW-D+ is a MMIC 2-way 0° splitter/combiner Die designed for wideband operation from DC to 8 GHz supporting many applications requiring high performance across a wide frequency range including all the LTE bands through WiMax an WiFi, as well as instrumentation and more. This model provides excellent power handling up to 0.6W (as a splitter/combiner) with low insertion loss, good isolation, and low phase and amplitude unbalance. Manufactured using GaAs IPD technology, the EP2RCW-D+ provides a high level of ESD protection and excellent repeatability.

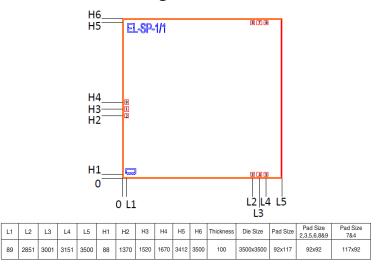
Simplified Schematic and Pad Description



| Pad# | Function | | |
|-------------|-------------------|--|--|
| 1 | Sum Port (RF IN) | | |
| 4 | Port 1 (RF OUT 1) | | |
| 7 | Port 2 (RF OUT 2) | | |
| 2,3,5,6,8,9 | Ground | | |

Note: 1. Bond Pad material - Gold 2. Bottom of Die is ground - Gold plated

Bonding Pad Position





+RoHS Compliant The +Suffix identifies RoHS Compliance. See our web site for RoHS Compliance methodologies and qualifications

Ordering Information: Refer to Last Page



Electrical Specifications at 25°C¹

| Р | arameter | Frequency (GHz) | Min. | Тур. | Max. | Unit | |
|------------------------------|---------------|--------------------|------|------|------|--------|--|
| Frequency Range | | | DC | | 8 | GHz | |
| Insertion Loss, above 3.0 dB | | DC - 0.4 | _ | 5.4 | _ | | |
| | | 0.4 - 0.7 | — | 5.4 | _ | 10 | |
| | | 0.7 - 7.5 | — | 4.5 | _ | dB | |
| | | 7.5 - 8.0 | — | 3.7 | _ | | |
| | | DC - 0.4 | _ | 16.9 | _ | | |
| | | 0.4 - 0.7 | — | 19.3 | _ | | |
| Isolation | | 0.7 - 7.5 | _ | 22.3 | _ | dB | |
| | | 7.5 - 8.0 | _ | 21.9 | _ | | |
| | | DC - 0.4 | _ | 0.1 | _ | | |
| | | 0.4 - 0.7 | _ | 0.1 | _ | Degree | |
| Phase Unbalance | | 0.7 - 7.5 | _ | 0.1 | _ | | |
| | | 7.5 - 8.0 | _ | 0.2 | _ | | |
| | | DC - 0.4 | | 0.1 | _ | | |
| | | 0.4 - 0.7 | _ | 0.1 | _ | | |
| Amplitude Unbalance | | 0.7 - 7.5 | _ | 0.1 | _ | dB | |
| | | 7.5 - 8.0 | _ | 0.1 | _ | | |
| | | DC - 0.4 | _ | 1.1 | _ | | |
| | | 0.4 - 0.7 | _ | 1.1 | _ | :1 | |
| VSWR (Port S) | | 0.7 - 7.5 | _ | 1.6 | _ | | |
| | | 7.5 - 8.0 | _ | 1.3 | _ | | |
| VSWR (Port 1-2) | | DC - 0.4 | _ | 1.6 | _ | :1 | |
| | | 0.4 - 0.7 | _ | 1.8 | _ | | |
| | | 0.7 - 7.5 | _ | 1.7 | _ | | |
| | | 7.5 - 8.0 | _ | 1.2 | _ | | |
| | As a splitter | DC - 8 | _ | _ | 0.6 | | |
| Power Handling | As a combiner | DC - 8 | _ | - | 0.6 | W | |

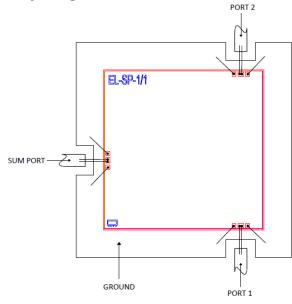
1. Measured on die using MPI Titan series 150 μm pitch as probe

Maximum Ratings

| Parameter | Ratings |
|-----------------------|----------------|
| Operating Temperature | -55°C to 105°C |

Permanent damage may occur if any of these limits are exceeded.

Assembly Diagram



Assembly and Handling Procedure

- 1. Storage
 - Dice should be stored in a dry nitrogen purged desiccators or equivalent.
- 2. ESD

MMIC dice are susceptible to electrostatic and mechanical damage. Die are supplied in antistatic protected material, which should be opened in clean room conditions at an appropriately grounded anti-static workstation. Devices need careful handling using correctly designed collets, vacuum pickup tips or sharp antistatic tweezers to deter ESD damage to dice.

3. Die Attach

The Die mounting surface must be clean and flat. Using conductive silver filled epoxy, recommended epoxies are DieMat DM6030HK-PT/H579 or Ablestik 84-1LMISR4. Apply sufficient epoxy to meet required epoxy bond line thickness, epoxy fillet height and epoxy coverage around total Die periphery. Parts shall be cured in a nitrogen filled atmosphere per manufacturer's cure condition. It is recommended to use antistatic Die pick up tools only.

4. Wire Bonding

Bond pad openings in the surface passivation above the bond pads are provided to allow wire bonding to the dice gold bond pads. Thermosonic bonding is used with minimized ultrasonic content. Bond force, time, ultrasonic power and temperature are all critical parameters. Suggested wire is pure gold, 1 mil diameter. Bonds must be made from the bond pads on the Die to the package or substrate. All bond wires should be kept as short as low as reasonable to minimize performance degradation due to undesirable series inductance.



| Additional Detailed Technical Information additional information is available on our dash board. | | | | | | |
|-----------------------------------------------------------------------------------------------------|-------------------------------------------------------------------------|-----------------------------------------------------------------------------|--|--|--|--|
| Performance Data | Data Table | Data Table | | | | |
| | Swept Graphs | Swept Graphs | | | | |
| | S-Parameter (S3P Files) Data Set with | S-Parameter (S3P Files) Data Set with and without port extension(.zip file) | | | | |
| Case Style | Die | | | | | |
| Die Ordering and packaging information | Quantity, Package | Model No. | | | | |
| | Small, Gel - Pak: 5,10 Medium [†] , Partial wafer: 225 Max. | EP2RCW-DG+ EP2RCW-DP+ | | | | |
| | [†] Available upon request contact sales representative | | | | | |
| | Refer to <u>AN-60-067</u> | | | | | |
| Environmental Ratings | ENV-80 | | | | | |

ESD Rating**

Human Body Model (HBM): Class 2 (Pass 2000V) in accordance with ANSI/ESD STM 5.1 - 2001

** Tested in industry standard, 5x5mm, 32-lead MCLP package.

Additional Notes

- A. Performance and quality attributes and conditions not expressly stated in this specification document are intended to be excluded and do not form a part of this specification document.
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2 Way-0° Power Splitter/Combiner Die EP2RCW-D+

Typical Performance Data

| TEST CONDITIONS: Input Power = -10dBm @Temperature = +25°C | | | | | | | | |
|------------------------------------------------------------|--------------|---------------------|----------------|-----------------|----------------|--------------|--------------|--------------|
| FREQ. | TOTAL | LOSS ⁽¹⁾ | AMP. UNBAL. | PHASE UNBAL. | ISOLATION | VSWR | | |
| (MHz) | (dB) | (dB) | (dB) | (deg.) | (dB) | | (:1) | |
| | S-1 | S-2 | | | 2-1 | S | 1 | 2 |
| 100 | 8.43 | 8.38 | 0.05 | 0.01 | 16.38 | 1.11 | 1.57 | 1.57 |
| 200 | 8.44 | 8.39 | 0.05 | 0.00 | 16.82 | 1.11 | 1.61 | 1.62 |
| 300 | 8.45 | 8.40 | 0.05 | 0.01 | 17.43 | 1.11 | 1.66 | 1.67 |
| 400 | 8.45 | 8.40 | 0.05 | 0.01 | 18.15 | 1.12 | 1.71 | 1.72 |
| 500 | 8.45 | 8.41 | 0.05 | 0.01 | 18.90 | 1.13 | 1.76 | 1.76 |
| 600 | 8.45 | 8.40 | 0.04 | 0.00 | 19.65 | 1.14 | 1.79 | 1.80 |
| 700 | 8.45 | 8.40 | 0.05 | 0.01 | 20.38 | 1.15 | 1.82 | 1.83 |
| 800 | 8.44 | 8.39 | 0.05 | 0.01 | 21.08 | 1.16 | 1.85 | 1.85 |
| 900 | 8.43 | 8.39 | 0.04 | 0.01 | 21.74 | 1.18 | 1.86 | 1.87 |
| 1000 | 8.42 | 8.37 | 0.04 | 0.00 | 22.34 | 1.20 | 1.88 | 1.89 |
| 1200 | 8.39 | 8.35 | 0.04 | 0.02 | 23.38 | 1.24 | 1.90 | 1.91 |
| 1400 | 8.35 | 8.31 | 0.04 | 0.01 | 24.17 | 1.29 | 1.91 | 1.92 |
| 1600 | 8.31 | 8.27 | 0.04 | 0.01 | 24.72 | 1.35 | 1.92 | 1.93 |
| 1800 | 8.26 | 8.22 | 0.04 | 0.02 | 25.02 | 1.41 | 1.91 | 1.93 |
| 2000 | 8.21 | 8.17 | 0.04 | 0.01 | 25.06 | 1.47 | 1.91 | 1.92 |
| 2200 | 8.15 | 8.11 | 0.04 | 0.02 | 24.90 | 1.54 | 1.90 | 1.91 |
| 2400 | 8.09 | 8.05 | 0.04 | 0.02 | 24.56 | 1.61 | 1.89 | 1.90 |
| 2600 | 8.01 | 7.98 | 0.04 | 0.02 | 24.10 | 1.67 | 1.87 | 1.88 |
| 2800 | 7.94 | 7.90 | 0.03 | 0.04 | 23.54 | 1.72 | 1.85 | 1.86 |
| 3000 | 7.86 | 7.83 | 0.03 | 0.07 | 22.96 | 1.75 | 1.82 | 1.83 |
| 3200 | 7.78 | 7.75 | 0.04 | 0.07 | 22.36 | 1.77 | 1.79 | 1.80 |
| 3400 | 7.70 | 7.66 | 0.04 | 0.09 | 21.80 | 1.78 | 1.75 | 1.76 |
| 3600 | 7.60 | 7.57 | 0.03 | 0.12 | 21.33 | 1.76 | 1.71 | 1.72 |
| 3800 | 7.51 | 7.47 | 0.04 | 0.14 | 20.96 | 1.72 | 1.66 | 1.68 |
| 4000 | 7.42 | 7.38 | 0.04 | 0.09 | 20.74 | 1.67 | 1.62 | 1.64 |
| 4200 4400 | 7.33 7.25 | 7.29 7.20 | 0.04 0.04 | 0.09 0.07 | 20.70 | 1.61 1.56 | 1.58 1.56 | 1.60 1.57 |
| 4400 | 7.23 | 7.20 | 0.04 | 0.07 | 20.82 21.07 | 1.50 | 1.56 | 1.57 |
| 4800 | 7.17 | 7.13 | 0.04 | 0.08 | 21.07 21.40 | 1.52 | 1.54 | 1.55 |
| 5000 | 7.07 | 7.07 | 0.04 | 0.08 | 21.40 | 1.53 | 1.53 | 1.54 |
| 5200 | 7.04 | 7.00 | 0.04 | 0.03 | 22.00 | 1.58 | 1.53 | 1.54 |
| 5400 | 7.04 | 6.99 | 0.03 | 0.07 | 22.00 | 1.65 | 1.53 | 1.55 |
| 5600 | 7.02 | 6.98 | 0.03 | 0.11 | 22.14 | 1.73 | 1.54 | 1.55 |
| 5800 | 7.01 | 6.98 | 0.03 | 0.07 | 22.04 | 1.81 | 1.54 | 1.55 |
| 6000 | 6.99 | 6.98 | 0.01 | 0.12 | 21.84 | 1.87 | 1.54 | 1.55 |
| 6200 | 6.97 | 6.95 | 0.02 | 0.23 | 21.58 | 1.89 | 1.53 | 1.54 |
| 6400 | 6.92 | 6.89 | 0.03 | 0.23 | 21.36 | 1.87 | 1.51 | 1.52 |
| 6600 | 6.86 | 6.83 | 0.03 | 0.23 | 21.23 | 1.80 | 1.48 | 1.49 |
| 6800 | 6.80 | 6.76 | 0.03 | 0.22 | 21.20 | 1.69 | 1.44 | 1.45 |
| 7000 | 6.73 | 6.70 | 0.04 | 0.21 | 21.29 | 1.55 | 1.38 | 1.40 |
| 7200 | 6.67 | 6.64 | 0.03 | 0.21 | 21.48 | 1.40 | 1.32 | 1.34 |
| 7400 | 6.64 | 6.61 | 0.04 | 0.22 | 21.72 | 1.27 | 1.27 | 1.28 |
| 7600 | 6.65 | 6.62 | 0.04 | 0.20 | 21.89 | 1.21 | 1.22 | 1.23 |
| 7800 | 6.70 | 6.67 | 0.04 | 0.19 | 21.90 | 1.27 | 1.18 | 1.19 |
| 8000 | 6.80 | 6.76 | 0.04 | 0.21 | 21.70 | 1.38 | 1.16 | 1.17 |
| 8200 | 6.93 | 6.89 | 0.04 | 0.17 | 21.35 | 1.49 | 1.16 | 1.17 |
| 8400 | 7.08 | 7.04 | 0.04 | 0.19 | 20.90 | 1.55 | 1.16 | 1.17 |
| 8600 | 7.27 | 7.23 | 0.04 | 0.17 | 20.42 | 1.57 | 1.17 | 1.18 |
| 8800 | 7.49 | 7.45 | 0.04 | 0.17 | 19.91 | 1.55 | 1.17 | 1.19 |
| 9000 | 7.75 | 7.71 | 0.04 | 0.17 | 19.45 | 1.53 | 1.18 | 1.20 |
| 9200 | 8.07 | 8.02 | 0.04 | 0.19 | 19.22 | 1.56 | 1.20 | 1.21 |
| 9400 | 8.42 | 8.37 | 0.05 | 0.16 | 19.55 | 1.55 | 1.20 | 1.22 |
| 9600 | 8.93 | 8.88 | 0.05 | 0.13 | 20.45 | 1.35 | 1.20 | 1.22 |
| 9800 | 10.16 | 10.11 | 0.05 | 0.13 | 19.28 | 1.08 | 1.28 | 1.29 |
| 10000 | 12.98 | 12.93 | 0.05 | 0.07 | 15.68 | 1.90 | 1.47 | 1.49 |

TEST CONDITIONS: Input Power = -10dBm @Temperature = +25°C

¹Total Loss = Insertion Loss + 3dB Splitter Loss

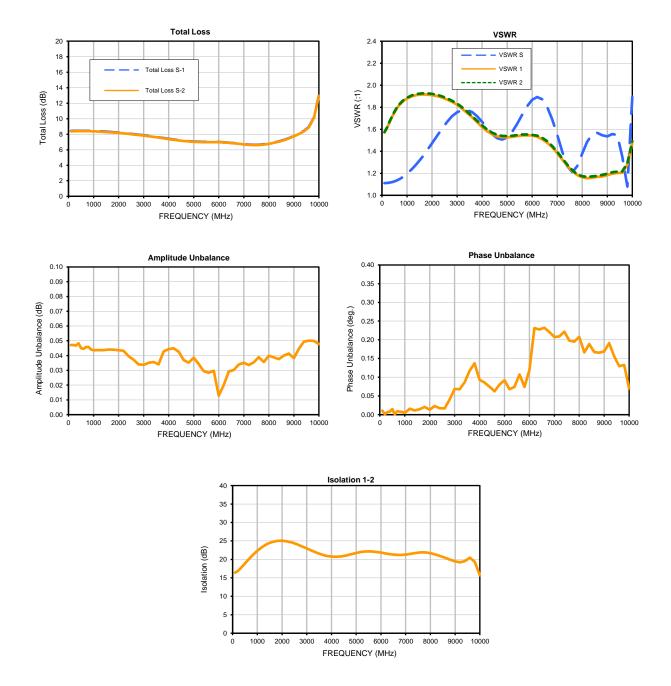




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Typical Performance Curves







P.O. Box 350166, Brooklyn, New York 11235-0003 (718) 934-4500 • Fax (718) 332-4661 For detailed performance specs & shopping online see Mini-Circuits web site The Design Engineers Search Engine Provides ACTUAL Data Instantly From MINI-CIRCUITS At: www.minicircuits.com IF/RF MICROWAVE COMPONENTS

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All Mini-Circuits products are manufactured under exacting quality assurance and control standards, and are capable of meeting published specifications after being subjected to any or all of the following physical and environmental test.

| Specification | Test/Inspection Condition | Reference/Spec |
|--------------------------------|-----------------------------------------------------------------------------------------------|--------------------------------------|
| Operating Temperature | -40° to 85° C or -40° to 105° C or -55° to 105° C or -45° to 105° C Ambient Environment | Refer to Individual Model Data Sheet |
| Storage Environment (Die) | -65° to 150°C | Individual Model Data Sheet |
| Storage Environment(Packaging) | -40° to 70°C and 40 to 60% humidity (In Factory Shipped Package) | |

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